**10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state** 

Rev. 4 — 2 April 2013

**Product data sheet** 

### 1. General description

The 74LVC841A is a 10-bit transparent latch featuring separate D-type inputs for each latch and 3-state outputs for bus applications. A latch enable (pin  $\overline{LE}$ ) input and an output enable (pin  $\overline{OE}$ ) input are common to all internal latches. The device consists of ten transparent latches with 3-state true outputs. When pin LE is HIGH, data at the Dn inputs enters the latches. In this condition, the latches are transparent, that is, a latch output changes each time its corresponding D-input changes. When pin  $\overline{LE}$  is LOW, the latches store the information that was present at the D-inputs a set-up time preceding the HIGH to LOW transition of pin  $\overline{LE}$ .

When pin  $\overline{OE}$  is LOW, the contents of the ten latches are available at the outputs. When pin  $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the pin  $\overline{OE}$  input does not affect the state of the latches.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

### 2. Features and benefits

- 5 V tolerant inputs/outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Flow-through pinout architecture
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

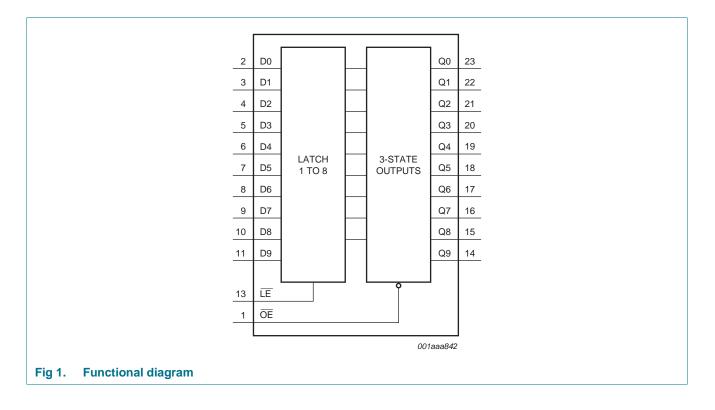


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#### **Ordering information** 3.

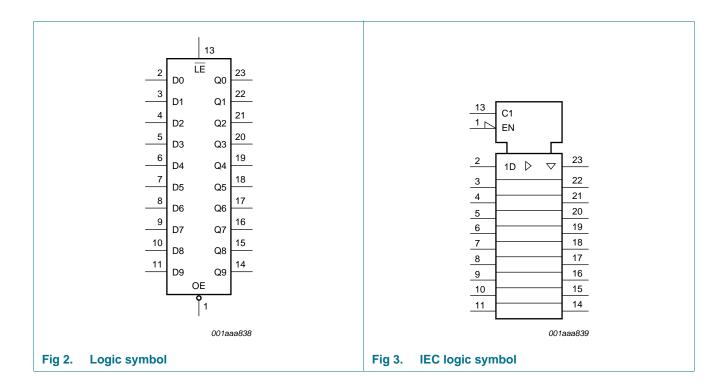
Type number	Package	Package						
	Temperature range	Name	Description	Version				
74LVC841AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-				
74LVC841ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-				
74LVC841APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-				
74LVC841ABQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm	SOT815-				

## 4. Functional diagram



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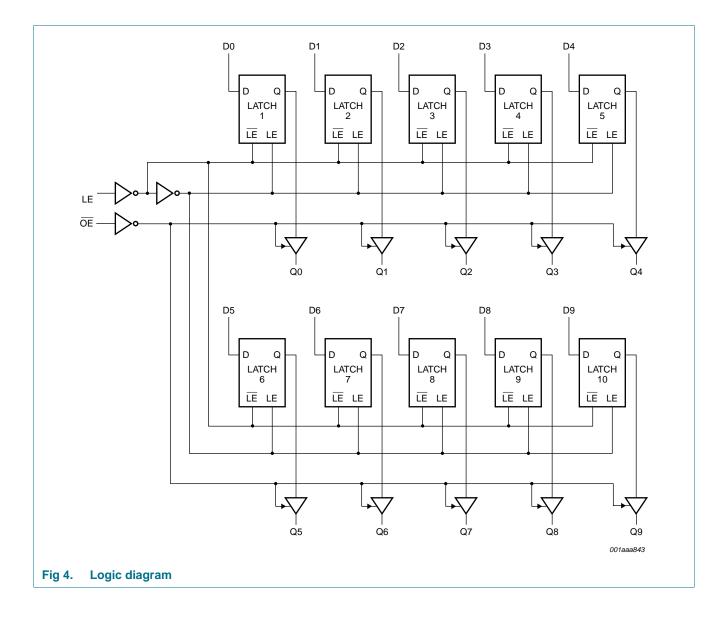
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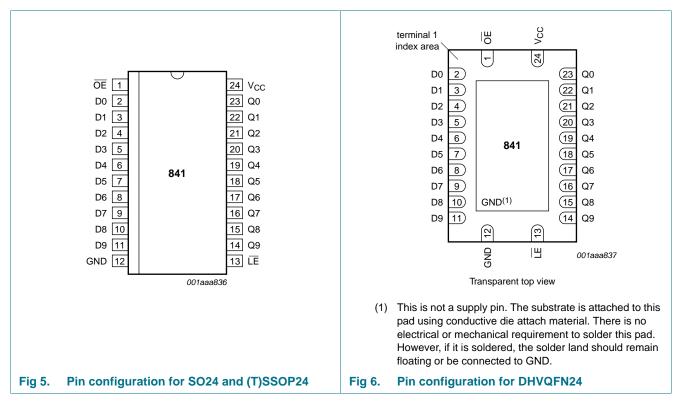
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## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2.	Pin description	
Pin	Symbol	Description
1	OE	output enable input (active LOW)
12	GND	ground (0 V)
13	LE	latch enable input (active LOW)
D[0:9]	2, 3, 4, 5, 6, 7, 8, 9, 10, 11	data input
Q[0:9]	23, 22, 21, 20, 19, 18, 17, 16, 15, 14	3-state latch output
24	V <sub>CC</sub>	supply voltage

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## 6. Functional description

#### Table 3.Function table<sup>[1]</sup>

Operating mode	Input		Internal latches	s Output	
	OE	LE	Dn		Qn
Enable and read register (transparent mode)	L	Н	L	L	L
	L	Н	Н	Н	Н
Latch and read register	L	L	Ι	L	L
	L	L	h	Н	Н
Latch register and disable	Н	L	Ι	L	Z
outputs	Н	L	h	Н	Z
Hold	L	L	Х	NC	NC

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the HIGH to LOW LE transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the HIGH to LOW LE transition

Z = high-impedance OFF-state

X = don't care

NC = no change

## 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		[1] -0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	HIGH or LOW state	[2] -0.5	V <sub>CC</sub> + 0.5	V
		3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO24 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP24 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN24 packages: above 60 °C derate linearly with 4.5 mW/K.

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## 8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	3.6	V
		functional	1.2	-	V
VI	input voltage		0	5.5	V
Vo	output voltage	HIGH or LOW state	0	V <sub>CC</sub>	V
		3-state	0	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	0	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	0	10	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	S5 ℃	–40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V
		I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V	-	-	0.55	-	0.8	V
I	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA
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#### 10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

Symbol	Parameter	Conditions	-40	°C to +85	°C	–40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
I <sub>OZ</sub>	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{IH} \text{ or } V_{IL};  V_{CC} = 3.6 \ \text{V}; \\ V_{O} = 5.5 \ \text{V} \text{ or } \text{GND}; \end{array}$	-	0.1	±5	-	±20	μA
I <sub>OFF</sub>	power-off leakage current	$V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	0.1	±10	-	±20	μA
I <sub>CC</sub>	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to $V_{CC}$	-	5.0	-	-	-	pF

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	-40 °C to	o +125 ℃	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation	Dn to Qn; see Figure 7	[2]						
	delay	V <sub>CC</sub> = 1.2 V		-	15	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.8	6.9	15.2	1.8	17.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.6	8.0	1.5	9.3	ns
	$V_{CC} = 2.7 V$		1.5	3.6	7.5	1.5	9.5	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.1	6.7	1.5	8.5	ns
		LE to Qn; see Figure 8	[2]						
		V <sub>CC</sub> = 1.2 V		-	17	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.3	7.9	17.7	2.3	20.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.7	4.1	9.1	1.7	10.5	ns
		$V_{CC} = 2.7 V$		1.5	3.8	8.6	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.5	7.6	1.5	9.5	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]						
		V <sub>CC</sub> = 1.2 V		-	19	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.8	7.6	16.5	1.8	19.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	4.3	9.1	1.5	10.5	ns
		$V_{CC} = 2.7 V$		1.5	4.3	8.5	1.5	11.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.4	7.2	1.5	9.0	ns

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Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	–40 °C to	• +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>dis</sub>	disable time	OE to Qn; see Figure 10	[2]						
		V <sub>CC</sub> = 1.2 V		-	8.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.6	4.4	9.8	2.6	11.3	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.5	5.5	1.0	6.4	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.6	1.5	8.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.1	5.9	1.5	7.5	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 8							
		$V_{CC}$ = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
	$V_{CC}$ = 2.3 V to 2.7 V		3.0	-	-	3.0	-	ns	
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.0	0.7	-	2.0	-	ns
t <sub>su</sub> set-up	set-up time	Dn to LE; see Figure 9							
		V <sub>CC</sub> = 1.65 V		3.5	-	-	3.5	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		2.0	-	-	2.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		2.0	1.0	-	2.0	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 9							
		V <sub>CC</sub> = 1.65 V		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.0	-	-	1.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	0.0	-	1.0	-	ns
t <sub>sk(o)</sub>	output skew time	$V_{CC}$ = 3.0 V to 3.6 V	<u>[3]</u>	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power	per input; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
	dissipation	$V_{CC}$ = 1.65 V to 1.95 V		-	5.8	-	-	-	pF
	capacitance	$V_{CC}$ = 2.3 V to 2.7 V		-	9.3	-	-	-	pF
		$V_{CC}$ = 3.0 V to 3.6 V		-	12.4	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

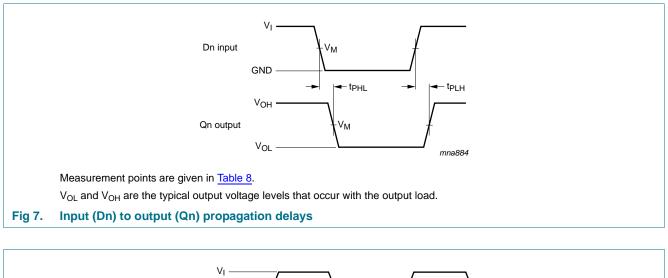
N = number of inputs switching

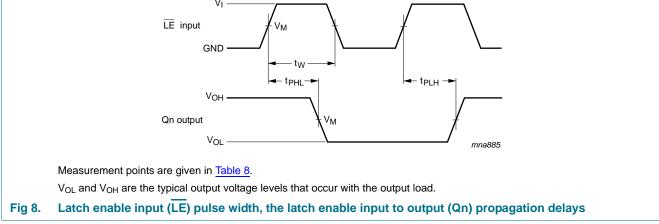
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs

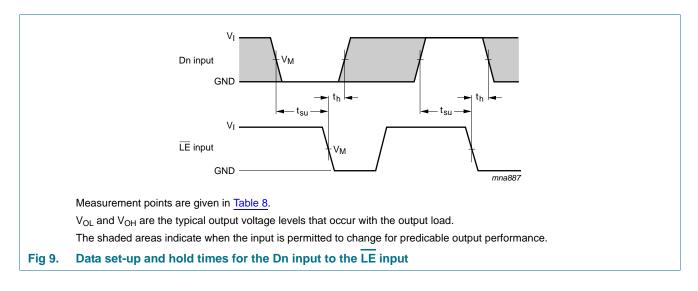
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## 11. Waveforms



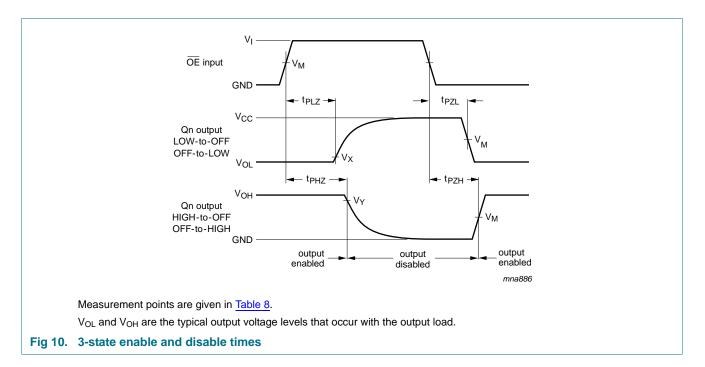




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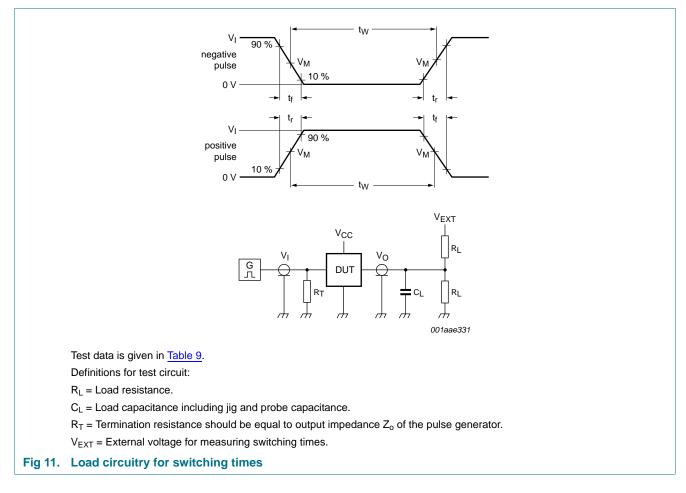


#### Table 8. Measurement points

Supply voltage	Input		Output	Output				
V <sub>cc</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
1.2 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5 \times V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$			
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 V$			

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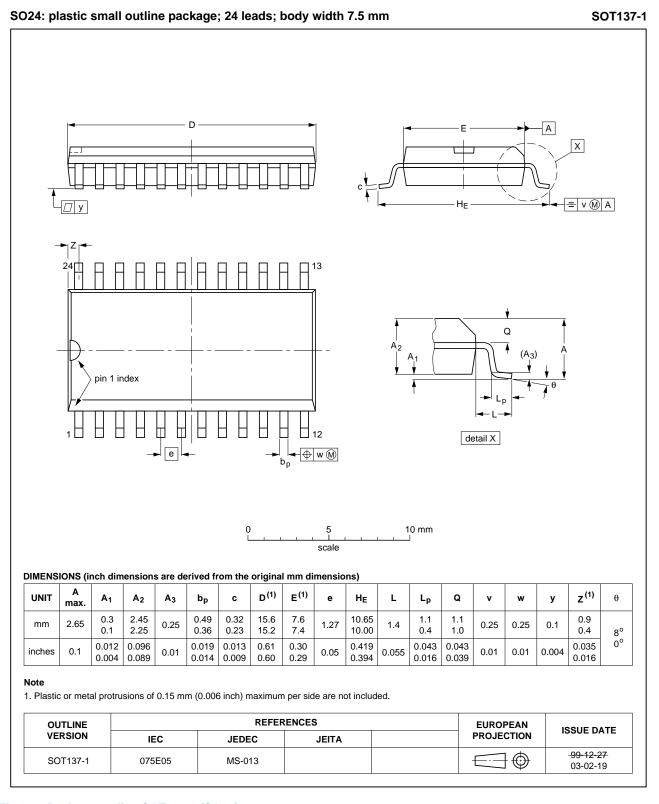
	Tabl	e 9.	Test	data
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Supply voltage	Input		Load	Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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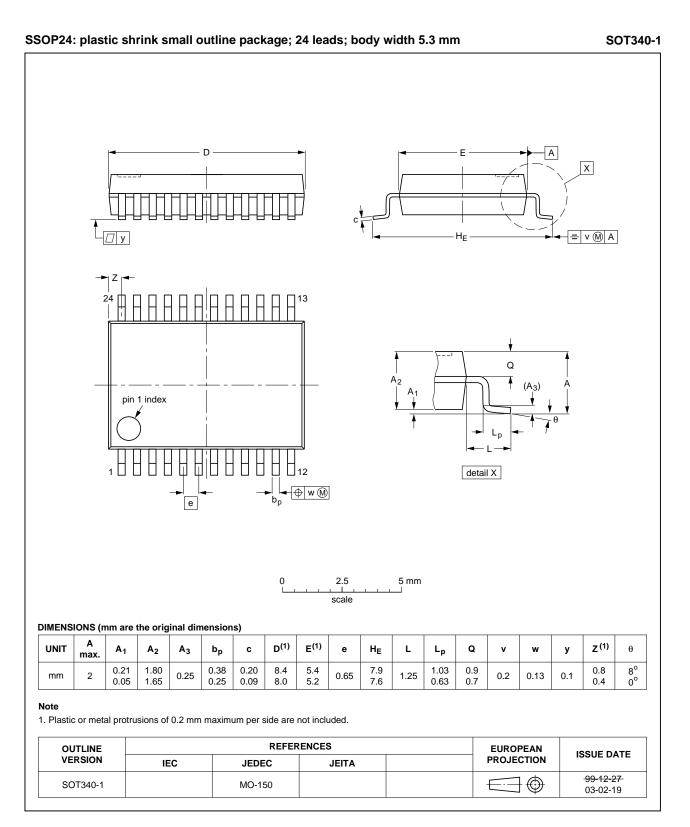
## 12. Package outline



### Fig 12. Package outline SOT137-1 (SO24)

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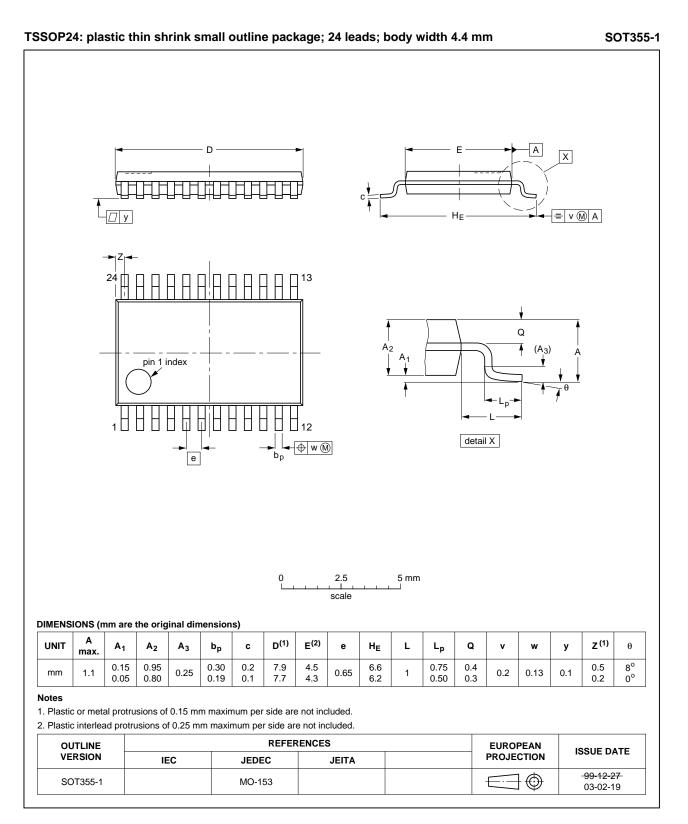
#### Fig 13. Package outline SOT340-1 (SSOP24)

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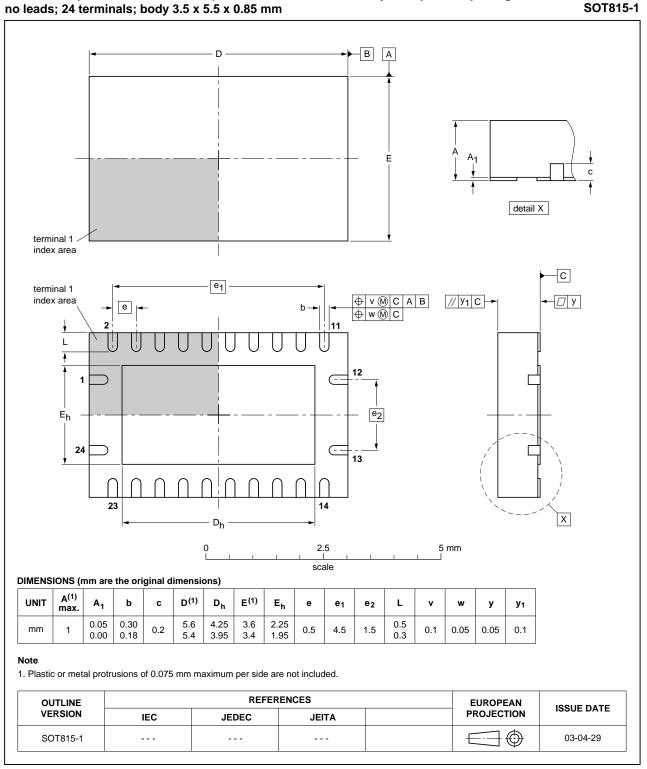
#### Fig 14. Package outline SOT355-1 (TSSOP24)

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## DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 15. Package outline SOT815-1 (DHVQFN24)

10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

## **13. Abbreviations**

Table 10. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

## 14. Revision history

Table 11. Revision	history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC841A v.4	20130402	Product data sheet	-	74LVC841A v.3	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>				
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
	• Table 4, Table	<u>5, Table 6, Table 7, Table 8</u> a	and <u>Table 9</u> : values ad	ded for lower voltage ranges.	
74LVC841A v.3	20040524	Product specification	-	74LVC841A v.2	
74LVC841A v.2	19980617	Product specification	-	74LVC841A v.1	
74LVC841A v.1	19980617	Product specification	-	-	

## **15. Legal information**

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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74LVC841A

Product data sheet

#### 10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

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# 74LVC841A

10-bit transparent latch with 5 V tolerant inputs/outputs; 3-state

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